

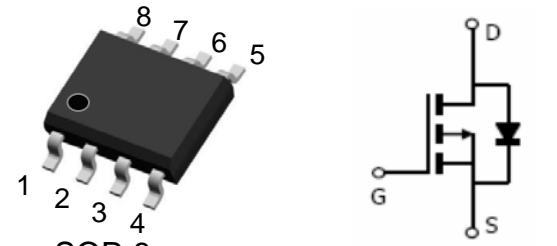
### P-Channel Enhancement-Mode MOSFET (-40V, -6A)

#### PRODUCT SUMMARY

$V_{DSS}$	$I_D$	$R_{DS(on)}$ (m $\Omega$ )TYP
-40V	-6.2A	16 @ $V_{GS} = -10V, I_D = -6A$
		21 @ $V_{GS} = -4.5V, I_D = -5A$

#### Features

- Advanced Trench Process Technology
- High Density Cell Design for Ultra Low On-Resistance
- Fully Characterized Avalanche Voltage and Current
- Improved Shoot-Through FOM
- Lead (Pb) -free and halogen-free

 <p>SOP-8</p> <p>Pin1/2/3: Source Pin4: Gate Pin5/6/7/8: Drain</p>	TOP Marking
	40P07

#### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	-40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current (Continuous)	-6.2	A
$I_{DM}$	Drain Current (Pulsed) <sup>a</sup>	-40	A
$P_D$	Total Power Dissipation @ $T_A = 25^\circ\text{C}$	2.0	W
$E_{AS}$ <sup>b</sup>	Avalanche Energy, Single pulse ( $L = 0.3\text{mH}$ )	35	mJ
$I_S$	Maximum Diode Forward Current	-6	A
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$R_{QJA}$	Maximum Junction-to-Ambient ( $t \leq 10\text{s}$ ) <sup>c</sup>	58	$^\circ\text{C/W}$
	Maximum Junction-to-Ambient (Steady State) <sup>c</sup>	78	$^\circ\text{C/W}$

a: Repetitive Rating: Pulse width limited by the maximum junction temperature.

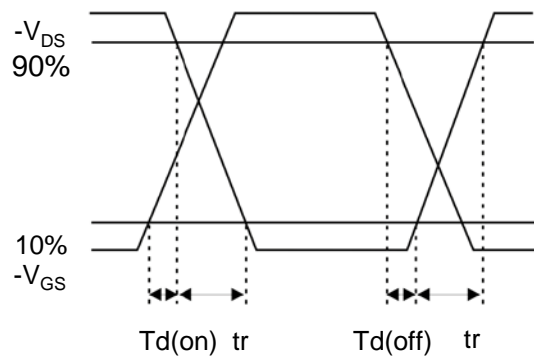
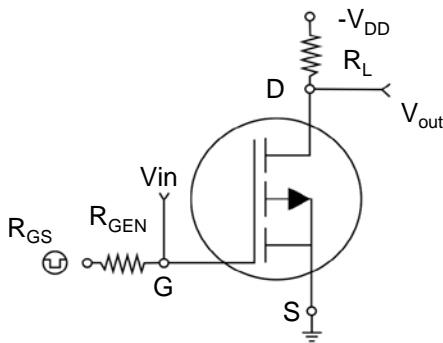
b: Surface Mounted on 1in<sup>2</sup> pad area,  $t < 10\text{sec}$ .

c: 1-in<sup>2</sup> 2oz Cu PCB board

### Electrical Characteristics ( $T_A=25^\circ\text{C}$ , unless otherwise noted)

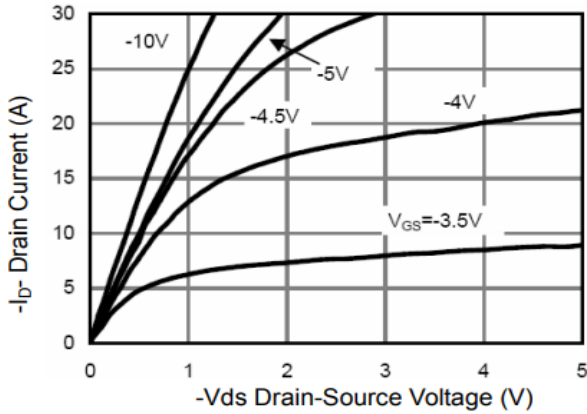
Symbol	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
<b>• Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-40	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-40V, V_{GS}=0V$	-	-	-1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
<b>• On Characteristics</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.1	-1.7	-2.5	V
$R_{DS(on)}$	Drain-Source On-State	$V_{GS}=-10V, I_D=-6A$	-	16	25	m $\Omega$
$R_{DS(on)}$	Drain-Source On-State	$V_{GS}=-4.5V, I_D=-5A$	-	21	30	m $\Omega$
<b>• Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$	-	1785	-	PF
$C_{oss}$	Output Capacitance		-	215	-	
$C_{rss}$	Reverse Transfer Capacitance		-	180	-	
<b>• Switching Characteristics</b>						
$Q_g$	Total Gate Charge	$V_{DS}=-15V, I_D=-9A, V_{GS}=-10V$	-	26	-	nC
$Q_{gs}$	Gate-Source Charge		-	3.6	-	
$Q_{gd}$	Gate-Drain Charge		-	7	-	
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=-15V, R_L=5\Omega, I_D=-2A, V_{GEN}=-10V, R_G=3\Omega$	-	8	-	nS
$t_r$	Turn-on Rise Time		-	7	-	
$t_{d(off)}$	Turn-off Delay Time		-	25	-	
$t_f$	Turn-off Fall Time		-	10	-	
<b>• Drain-Source Diode Characteristics</b>						
$V_{SD}$	Drain-Source Diode Forward	$V_{GS}=0V, I_S=-2.0A$	-	-	-1.3	V

Note: Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$

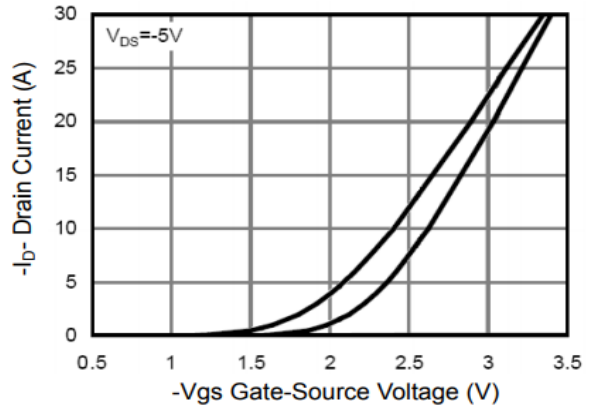


Switching Test Circuit and Switching Waveforms

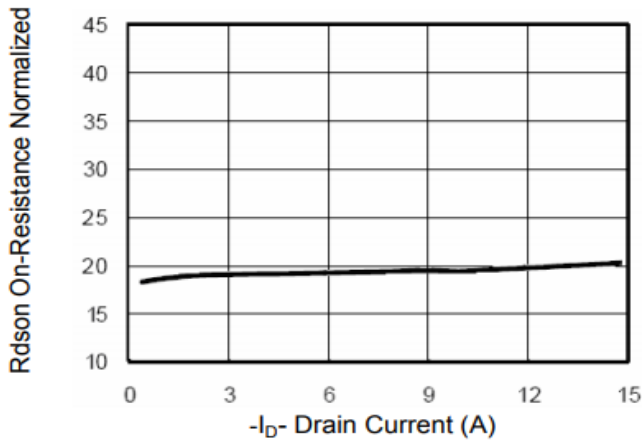
### Typical Characteristics Curves (Ta=25°C, unless otherwise note)



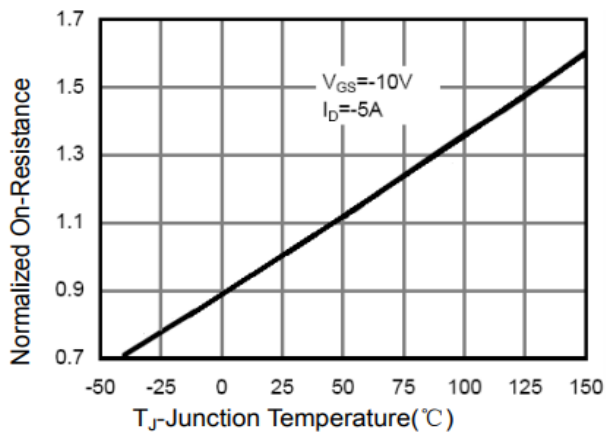
**Figure 1 Output Characteristics**



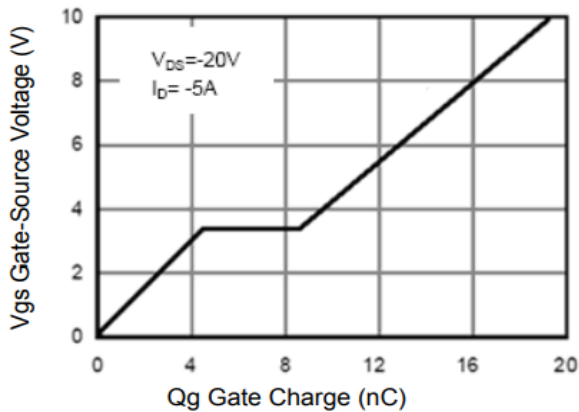
**Figure 2 Transfer Characteristics**



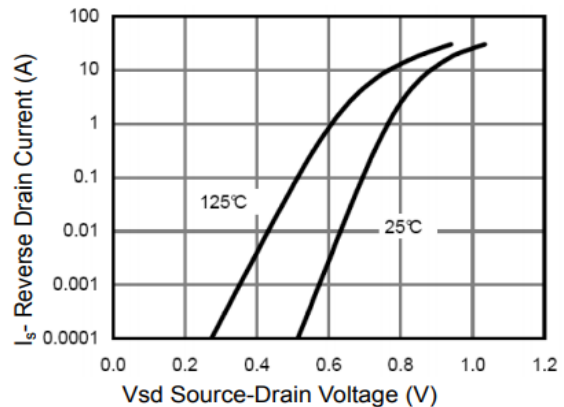
**Figure 3 Rdson- Drain Current**



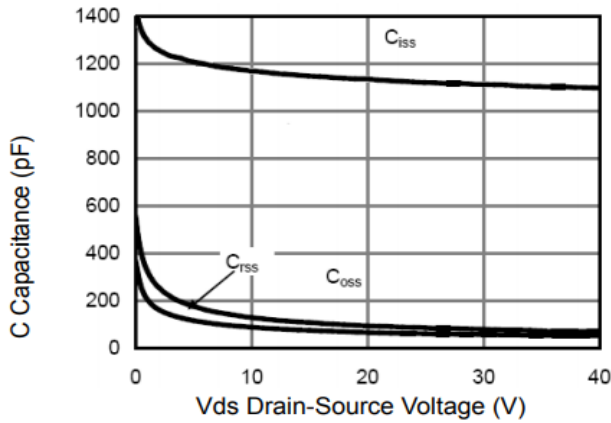
**Figure 4 Rdson-Junction Temperature**



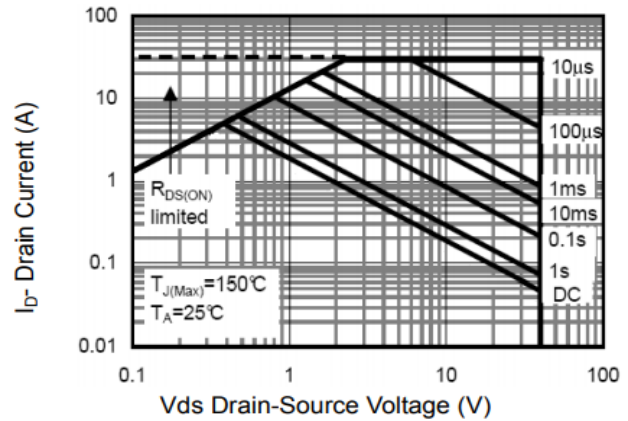
**Figure 5 Gate Charge**



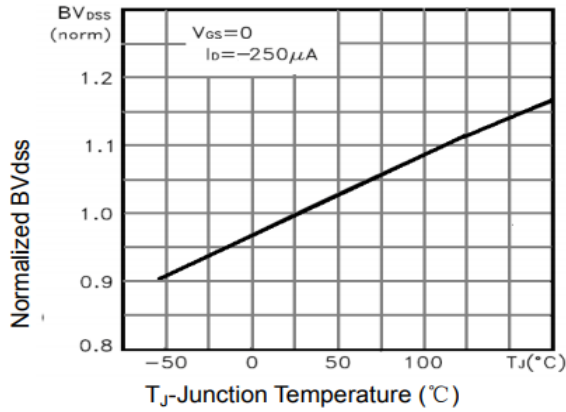
**Figure 6 Source- Drain Diode Forward**



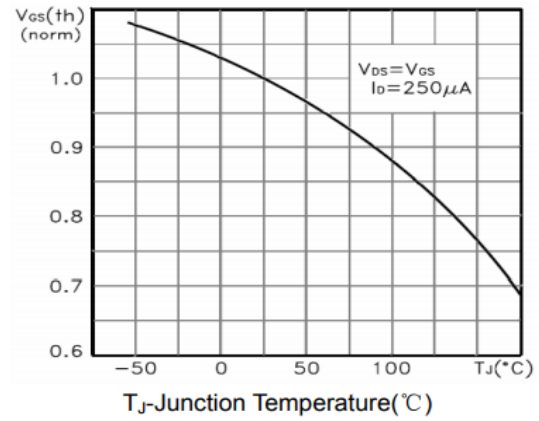
**Figure 7 Capacitance vs Vds**



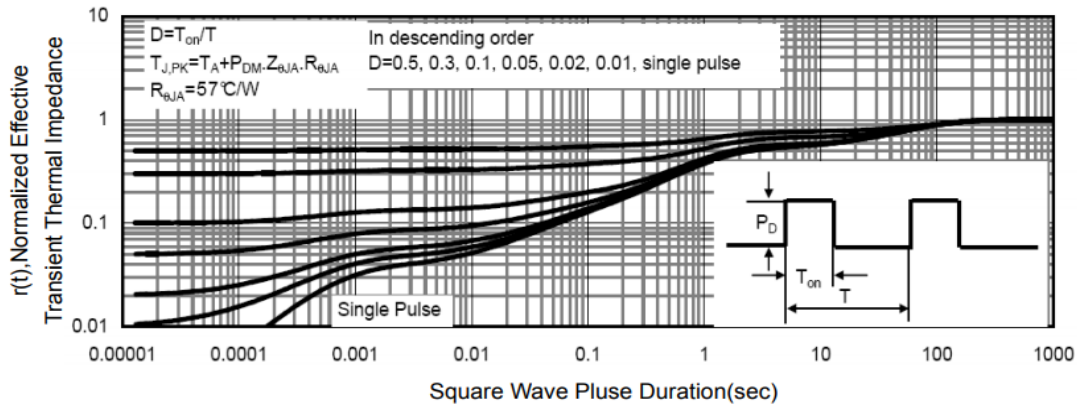
**Figure 8 Safe Operation Area**



**Figure 9 BV<sub>DSS</sub> vs Junction Temperature**

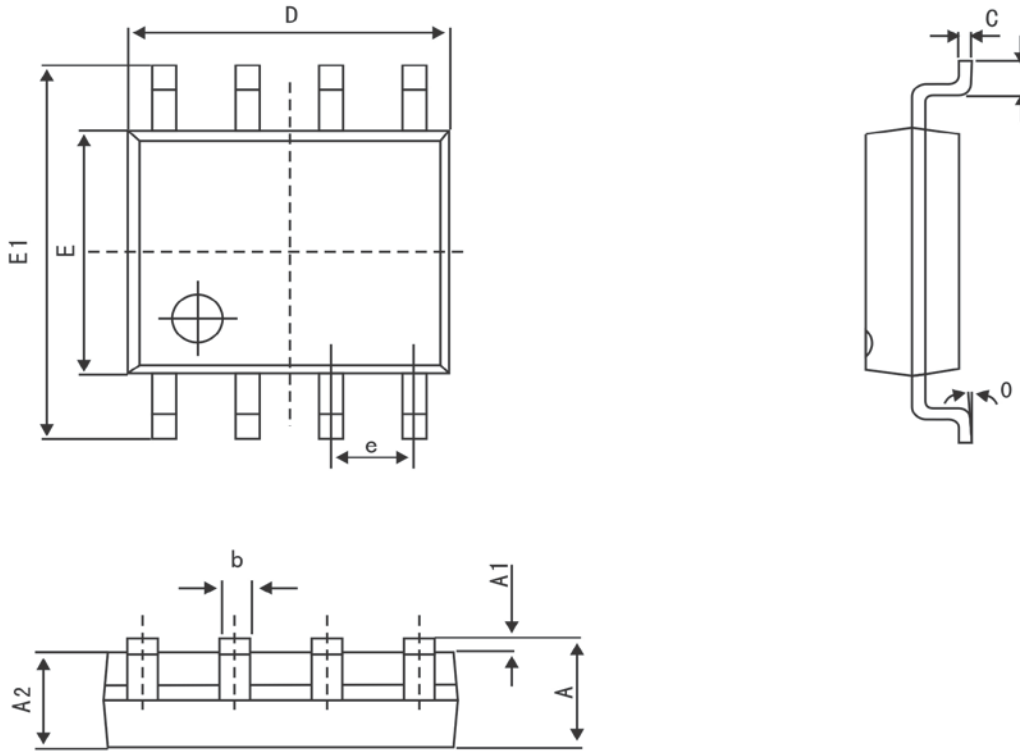


**Figure 10 V<sub>GS(th)</sub> vs Junction Temperature**



**Figure 11 Normalized Maximum Transient Thermal Impedance**

### SOP-8 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters (MM)		Dimensions In Inches (MIL)	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°